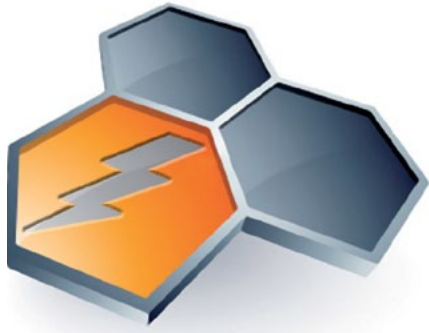




CARBON NANOTUBE  
CONDUCTIVE POLYMERS  
iPOLYCOND HANDBOOK





# iPOLYCOND

conductive polymers

English





### Picture this ...

Your mobile phone is lying on your desk, close to the speaker of your computer system. A few seconds before you receive a call or SMS message on your mobile phone, the speaker makes a buzzing noise. Is this clairvoyance of the speaker? No way. Here, the wire to the speaker acts like an antenna that picks up and amplifies the signal it receives from the mobile phone network. This is a typical example of electromagnetic interference between electronic components, and it shows that electromagnetic fields are all around us.

In order to protect sensitive electronic devices against unwanted electromagnetic interference, normally a shielding material is positioned between the source of the electromagnetic field and the sensitive component.

iPolyCond conducting polymer composites are among those materials that are able to shield against electromagnetic interference (EMI) and to protect against electrostatic discharge (ESD) in electronic devices. This booklet deals with some background and practical aspects of conducting polymer composites for shielding purposes.

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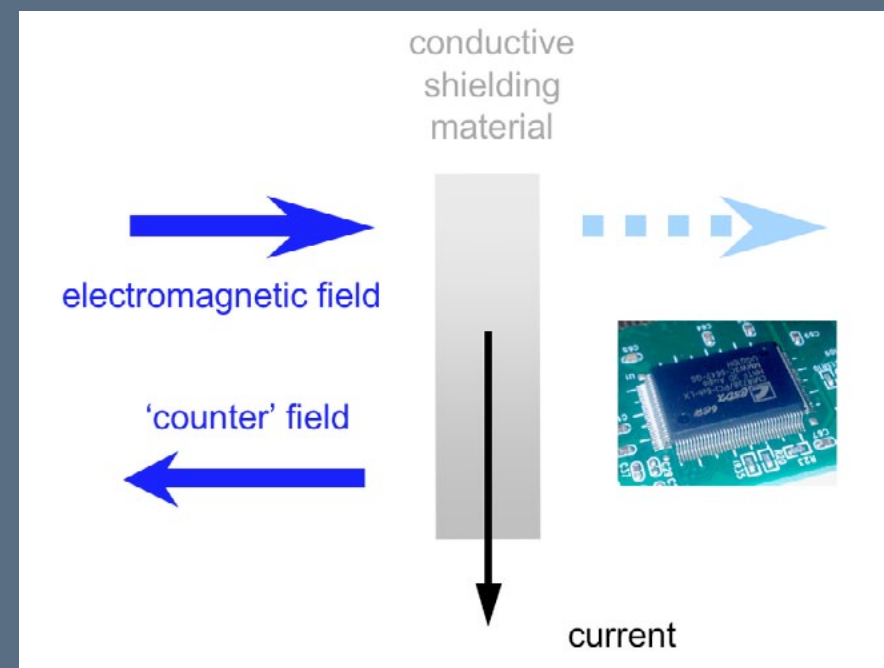
## The challenge ...

### Electromagnetic interference

Unwanted electromagnetic interference effects occur when sensitive devices receive electromagnetic radiation that is being emitted - whether intended or not - by other electric or electronic devices such as microwaves, wireless computers, radios and mobile phones. As a result, the affected receiving devices may malfunction or fail.

The effects of electromagnetic interference are becoming more and more pronounced, caused by the demand for high-speed electronic devices operating at higher frequencies, the more intensive use of electronics in e.g. computers, communication equipment and cars, and the miniaturisation of these electronics. For example, mobile phones and smartphones are typically operating at 800-4900 MHz, and around 2 GHz for data transmission through Universal Mobile Telecommunications Systems (UMTS). Compact, densely packed electronic components produce more electronic noise.

These trends indicate the need to protect components against electromagnetic interference (EMI) in order to decrease the chances of these components adversely affecting each other or the outer world. The effects of electromagnetic interference can be reduced or diminished by positioning a shielding material between the source of the electromagnetic field and the sensitive component. This protection may be achieved by making the housing of electronic components electronically conducting.



Electrical conductivity is a prerequisite for an EMI shielding material. This is due to the physical phenomenon that electric fields and varying magnetic fields induce currents in the electrically conducting shielding material. In turn, these currents generate counteracting fields which weaken - or in the ideal case cancel - the originally applied fields. Ideally, external fields stay outside the shielding material, and internal fields stay inside.

As EMI shielding is composed of reflection and absorption contributions, both the conductivity in the volume of the protecting material as well as the thickness of the material may be of importance. In a practical way, the extent of shielding is also subject to the size and shape of openings in the shield. For example, at a frequency of 5 GHz the opening must be less than 52 mm for effective EMI shielding.

Very much related to EMI shielding is the protection against electrostatic discharge (ESD) in electronic devices. ESD is the uncontrolled transfer of static charge between two objects with different electrical potential. For ESD protection surface conductivity is important, to allow a fast and controlled discharge of static charge.

## The solution ...

### Conductive polymer composites

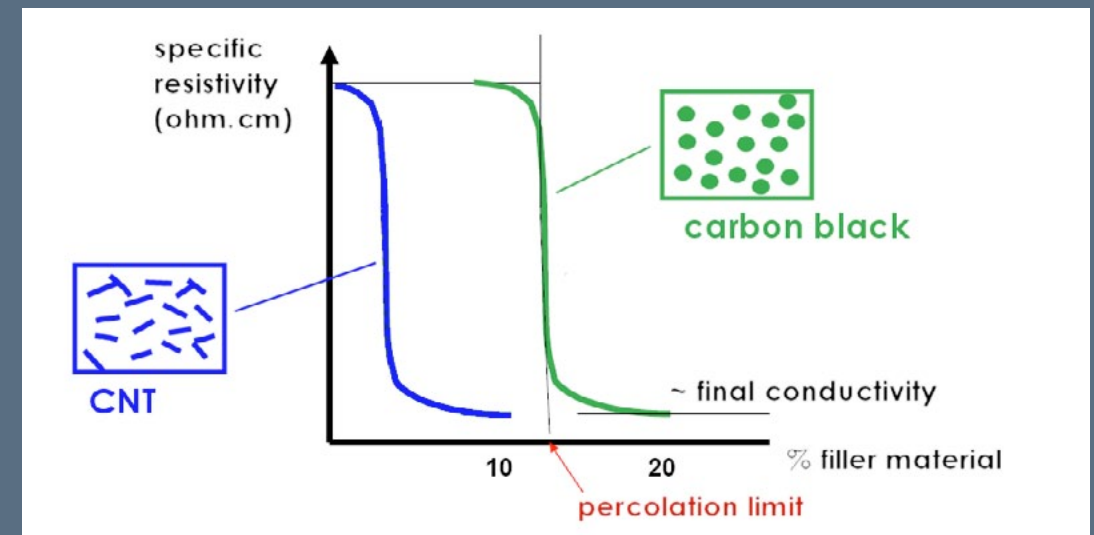
Housings for electronic products (e.g., computers, communication devices) and business equipment (including devices for payment processing) are often made of engineering plastics. A particular problem for shielding is that plastics generally have excellent electrical insulation properties (as can be seen from their usefulness as insulation for electric wires). With a typical electrical conductivity of  $<10^{-14} \text{ ohm}^{-1} \cdot \text{cm}^{-1}$ , these engineering plastics cannot shield electronic devices from electromagnetic radiation. For EMI shielding the conductivity should be  $>10^{-2} \text{ ohm}^{-1} \cdot \text{cm}^{-1}$ , resulting in a (volume) resistivity of  $<10^2 \text{ ohm} \cdot \text{cm}$ .

Filling a matrix of engineering plastic with small volume fractions of an electrically conductive material combines the availability of a housing made of shielding material with the advantages of traditional polymer processing techniques. These advantages include the use of existing compounding equipment - so no large new investments have to be made - and the ease of manufacturing small, complex shapes in a one-step process.

Several fillers can be used. Traditionally, metal or carbon-black particles have been used as electrically conductive filler materials. A high level of these fillers can be detrimental for the processability, density and surface quality of the material, the costs and mechanical properties of the moulded product, and may cause wear to the processing equipment. Therefore, an interesting solution is to use novel filler materials such as conductive carbon nanotubes (CNT) with a filler content that is as low as possible. In this way, conductivity and sufficient mechanical stability will be provided to the material while the original plastic processing properties will remain the same.

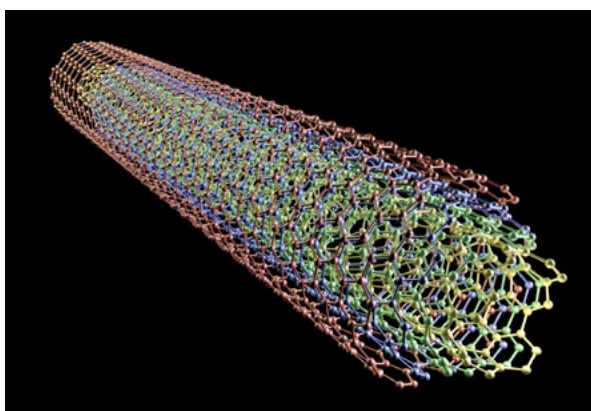
When the concentration of electrically conductive particles in a composite exceeds a certain level (the 'percolation limit'), the particles come into contact with each other and form a continuous path in the material for electrons to travel. In this way, the composite material has become electrically conductive. The conductivity of the filler material will be the upper limit for the electrical conductivity of the entire composite.

The percolation limit is dependent upon the shape of the conductive particles. For traditional spherical-shaped fillers at a random distribution,  $\sim 10\text{--}20\%$  has to be added before the composite will be electrically conductive. The higher the aspect ratio (length-to-width ratio) of the particles, the lower is the concentration for percolation needed to take place. CNT with a diameter of a few nanometres and a length of micrometres (i.e. a high aspect ratio) can form a conductive network at much lower volume fractions - and potentially lower costs - than cheaper, traditional fillers such as carbon fibre and carbon black.



Suitable matrix polymers	Benefits/properties of these polymers with CNT
Polypropylene (PP)	Good toughness possible
Polyamide 12 (PA 12)	Wire coating, high chemical resistance
Polyamide 6/66 (PA 6/66)	Tough, easy to mould, high temperature resistance
Polycarbonate (PC)	Much better properties than obtainable with carbon black
Polycarbonate/Acrylonitrile-Butadiene-Styrene (PC/ABS)	Very good toughness and good mouldability
Polycarbonate/Polybutylene terephthalate (PC/PBT)	Very good toughness for housings with UV resistance
Glass filled Polyphenylene sulfide (PPS)	Very high stiffness and very high temperature resistance
Thermoset Polyurethane (PU)	(Very) large mouldings

The incorporation of small volume fractions of novel, non-metallic electrically conducting fillers in a non-conducting plastic matrix by means of compounding as a one-step process forms the basis of conductive polymer composites. The filler materials used here are conductive carbon nanotubes (CNT). CNT, especially those of a multi-wall composition, multi-wall carbon nanotubes (MWCNT), which can best be described as multiple layers of graphite rolled in on themselves, are known to conduct electricity.



## Comparison with alternative solutions

Due to their high electrical conductivity ( $\sim 10^6 \text{ ohm}^{-1} \cdot \text{cm}^{-1}$ ), metals are particularly suitable as shielding material against electromagnetic fields. This can be a self-supporting full metal shielding, but also a sprayed, painted or electrolessly applied conductive coating (e.g., nickel) on a supporting material such as plastic. Another option is the incorporation of stainless steel powder or fibres as conductive filler in a plastic matrix.

However, there are a few drawbacks to using metal as a shielding material. The weight of the 'heavy' metal can be an issue in the case of full metal shielding and plastic matrices with high metal filler content, especially in applications in which mass should be as low as possible. Furthermore, metals are prone to corrosion. To produce metal coatings, at least two processing techniques must be applied - one for the support and one for the coating - which can be costly. It will also be difficult to apply these coatings onto complicated-shaped objects. In addition, the long-term adhesion of the coating to the support has to be reliable.

## Design & Processing

The most common technique for shaping complex plastic products (e.g. housings for electronic applications) is injection moulding. Many parameters can be varied in the injection moulding process, and many of these parameters can have a significant positive (+), negative (-) or neutral (0) influence on the shielding performance of the product:

Parameter	Volume resistivity	Surface resistivity	Reflection
Mould temperature increases	-	+	0
Mould temperature above $T_g$	-	+	-
Injection speed increases	---	++	-
Wall thickness increases			++
Distance from the gate increases			+
Surface texture		0	
Flow direction		-	



To **minimise shear** during filling of the part mould, it is advisable to avoid sharp corners in plastics parts, and to try to ease the flow by replacing the sharp corners by rounded ones. As part of the effect of shear stress in the part, on the design stage we have to minimise the sharp corners, giving them generous radii to expedite flow of the conductive melt.

Combining the use of **low velocities** with a **wider injection gate** facilitates the flow of the conductive plastic into the cavity. In this way, it is possible to ensure complete filling of the cavity without the need for increasing the injection speed. Higher speed profiles increase the possibility of shear stresses in the injected part.

It is possible to **cover all the range of usual part thicknesses** that have been used in the thermoplastic moulding industry. The use of parts with higher or lower thickness will be determined by the final properties or special requirements to reach in its use. The best reflection values were obtained on parts that were less thick.

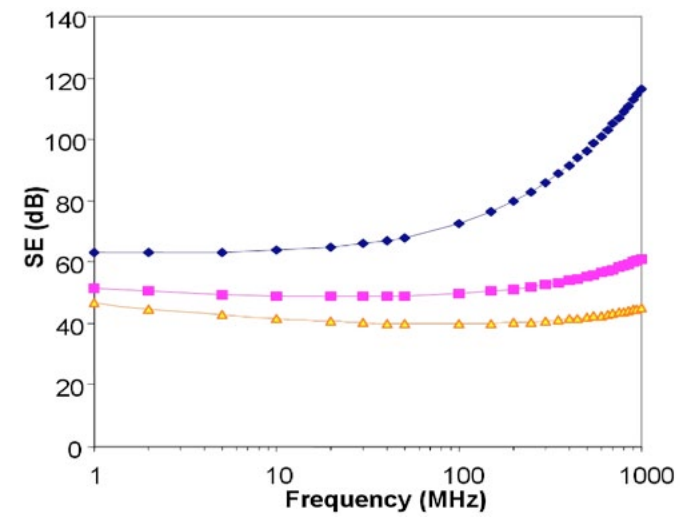
For **CNT** and **steel-fibre filled compounds**, it is necessary to **avoid extremely long flow lengths** because the longer the flow, the more shear is imparted to the compound, causing a loss of fibre integrity.

Based on our experience, the moulds should be designed to **minimise melt turbulence**, necessitating gates and runners that are larger than those for unfilled resins and similar to those used for other fibre filled materials.

Guidelines for gating of conductive filled materials include a **minimum gate depth of 1.5 mm**, with a preference for a gate depth of 2.3 mm to 2.5 mm. As a result, pinpoint, tunnel, and subgates are not recommended, and tab or sprue gates are preferred. Multiple gating may be necessary to achieve the best dispersion.

**Full circular runners** are recommended for optimum flow because this minimises the number of bends or turns to prevent masterbatch breakage. Cold slug wells are recommended at the end of 90° angles.

# Typical iPolyCond materials properties



iPolyCond polycarbonate nanotube and SS fibre hybrid material  
 Polycarbonate + SS fibres  
 Polycarbonate nanotube compound

## Electrical properties

Volume resistivity (ohm.cm)	Surface resistivity (kohm/sq)	Reflection (%)	Shielding efficiency at 100 MHz (dB)
$7 \times 10^{-3}$	100	76	37
700	10-1000	69	34
320	900	69	34
6	10-50	86	47
90	20-200	61	31
0.8	10-50	89	53
1000	20-2000	62	31

Material	
9103	PP + CNT
9104	PP + CNT/hybrid
9303	PC/ABS + CNT
9603	PC/PBT + CNT
9604	PC/PBT + CNT + SS
9703	PC + CNT
9704	PC + CNT + SS
9705	PC + CNT flame retarding

## Mechanical properties

Tensile stress at break (MPa)	Tensile strain at break (%)	Tensile modulus (MPa)	Flexural modulus (GPa)	Impact strength (kJ/m <sup>2</sup> )
20.6	80	1010	942	42
15.9	20.3	990	1020	9.3
41	18.9	2633	2075	21.1
47.9	13	2520	2339	36.7
60.3	4.3	2450	2840	10.1
61.9	8.0	2570	2703	7.1
64.9	7.1	2700	3020	8.8
65.0	12	2700	3100	11.0



## Applications

### Automotive part with EMI shielding properties

Original housing: Metal (high shielding level, expensive in production, heavy, design limitations)

iPolyCond solution: Polypropylene with polyaniline and carbon nanotubes, with the required EMI shielding protection

Improvements: Design flexibility, weight reduction, 25% cheaper, recyclable



### Blood pressure monitoring device

Original housing: Stainless steel fibre filled PC/ABS (difficult to manufacture, final product failed due to poor physical properties)

iPolyCond solution: PC/ABS filled with carbon nanotubes, with at least 30 dB shielding

Improvements: Toughness, recyclable, ease of manufacture, better surface quality

## Applications

### Military radio with high level EMI shielding

Original housing: Metal (high shielding level, expensive in production, heavy, design limitations)

iPolyCond solution: PC/PBT with carbon nanotubes and stainless steel fibres, with 60 dB shielding

Improvements: Toughness, easily moulded, 60% weight reduction, 40% cheaper



### Grounding plug earth pin

Original: Brass grounding pin (expensive, specialist product)

iPolyCond solution: Polycarbonate with carbon nanotubes

Improvements: Ease of manufacture, 80% weight reduction, plug is 40% cheaper, recyclable





Education and Culture DG

## Lifelong Learning Programme

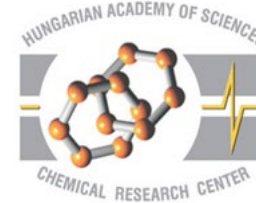
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Asociación de Investigación de Materiales  
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TBA Electro Conductive Products  
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Faperin  
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<http://www.promolding.nl>



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<http://www.betase.nl>



EuPC  
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**iPOLYCOND**  
conductive polymers

<http://www.ipolycond.org>



**ECP 9303**

**CONDUCTIVE PC/ABS  
CARBON NANOTUBE COMPOUND  
INJECTION MOULDING**

ECP 9303 is a proprietary TBA PS injection moulding compound utilising multi wall carbon nanotube technology to give a permanently conductive material. Special compounding techniques at low filler loadings ensure the retention of physical properties and excellent cleanliness.

**APPLICATIONS**

Mouldings made from ECP 9303 exhibit excellent dimensional and chemical stability, and mouldings are clean and non-sloughing.

Typical applications include:

- Production aids for the electronics industry (e.g., storage boxes, bins and PCB racks.
- Static safe handling equipment tools
- Static dissipating equipment housing
- Applications requiring a degree of EMI shielding

**PROPERTIES**

Parameter	Condition	Typical Value	Unit	Test method
Surface resistance	23+/-2C	1.0E+06	ohm/sq	BS 2044:1984 /3
Volume resistance	23+/-2C	7.0E+02	ohm.cm	BS 2044:1984 /3
EMI Shielding	100MHz/1 GHz	34/34	dB	Reflectometer
Specific Gravity		1.10	g/cm <sup>3</sup>	BS EN ISO 1183-1:2004
Melt flow rate	260C/5kg	1.6	g/10 min	ISO 1133:1991
Tensile strength at break	50mm/min	41	MPa	ISO 527-2:1997
Tensile modulus	1mm/min	2633	MPa	ISO 527-2:1997
Elongation at break	50mm/min	18.9	%	
Flexural modulus	2mm/min	2075	MPa	ISO 178:2003
Izod Impact	23+/-2C	21.1	KJ/m <sup>2</sup>	ISO179-1:2001
Heat deflection temp	1.8MPa	92.0	°C	BS EN ISO 75-1&2



## **RECOMMENDED PROCESSING CONDITIONS**

### **MACHINE**

It is recommended that an in-line reciprocating screw machine be used to injection mould ECP 9303.

### **CYLINDER TEMPERATURE**

260-290°C. The optimum cylinder temperature will depend upon the size and complexity of the moulding.

### **MOULD TEMPERATURE**

75-90°C. The optimum mould temperature will depend upon the size and complexity of the moulding.

### **MOULD DESIGN**

Moulds should be designed to obtain rapid filling, and multiple gates for large area mouldings are recommended with the gate positioned to avoid possible formation of weld lines.

### **MACHINE AND MOULD WEAR**

The intensive compounding action, which takes place during the manufacture of ECP 9603, ensures encapsulation of the reinforcement in polymer. This tends to minimise wear on injection screws and moulds. There is no evidence to show that ECP 9303 causes corrosion of mould steels.

### **MOISTURE**

ECP 9303 absorbs moisture, therefore, prior to moulding please ensure thorough drying (i.e., 100°C for min. 4 hours). Materials should be re-dried if all the material is not used within 2-3 hours of opening the bag. Excess moisture may show as splash marks on the surface of these finished mouldings. If necessary, the material should be re-dried at 90-100°C in shallow trays for 2-3 hours. Other forms of drying of equivalent effect are also suitable.

### **USE OF REGRIND**

Runners sprues and scrap mouldings can be reground and blended with virgin materials. Regrind additions should not exceed 10% by weight of the virgin material otherwise some reduction in properties may be experienced.

### **HEALTH & SAFETY**

**CAUTION - THIS MATERIAL IS ELECTRICALLY CONDUCTIVE**

As this material does not have the insulating properties normally associated with polymers, due safety precautions must be taken in use and it is recommended that all products made from this material are suitably labelled.

These materials are stable at ambient and normal processing temperatures and can be processed safely in moulding and extrusion equipment at up to 300°C.

**INFORMATION IN THIS PUBLICATION AND OTHERWISE SUPPLIED TO USERS IS BASED UPON OUR GENERAL EXPERIENCES AND IS GIVEN IN GOOD FAITH, BUT BECAUSE OF THE PARTICULARS WHICH ARE OUTSIDE OUR KNOWLEDGE AND CONTROL AND AFFECT THE USE OF THE PRODUCT, NO WARRANTY IS GIVEN OR IS IMPLIED WITH RESPECT TO SUCH INFORMATION. FREEDOM FROM PATENT RIGHTS MUST NOT BE ASSUMED.**



**Sales 01706 647718**

## ECP 9602

### **CONDUCTIVE PC/PBT CARBON NANOTUBE COMPOUND INJECTION MOULDING**

ECP 9602 is a proprietary TBA PS injection moulding compound utilising multi wall carbon nanotube technology to give a permanently conductive material. Special compounding techniques at low filler loadings ensure the retention of physical properties and excellent cleanliness.

#### APPLICATIONS

Mouldings made from ECP 9602 exhibit excellent dimensional and chemical stability, and mouldings are clean and non-sloughing, and process with good flow.

Typical applications include:

- Production aids for the electronics industry (e.g., storage boxes, bins and PCB racks.
- Static safe handling equipment tools, instruments.
- Static dissipating equipment housing and ATEX applications
- Applications requiring low level EMI shielding

#### PROPERTIES

Parameter	Condition	Typical Value	Unit	Test method
Surface resistance	23+/-2C	1.0E+08	ohm/sq	BS 2044:1984 /3
Volume resistance	23+/-2C	8.0E+02	ohm.cm	BS 2044:1984 /3
Specific Gravity		1.22	g/cm <sup>3</sup>	BS EN ISO 1183-1:2004
Melt flow rate	250C/5kg	6.7	g/10 min	ISO 1133:1991
Tensile strength at break	50mm/min	45.8	MPa	ISO 527-2:1997
Tensile modulus	1mm/min	1.54	GPa	ISO 527-2:1997
Elongation at break	50mm/min	14.7	%	
Flexural modulus	1mm/min	2.88	GPa	ISO 178:2003
Izod Impact	23+/-2C	43.3	KJ/m <sup>2</sup>	ISO179-1:2001
Heat deflection temp	1.8MPa	92.0	C	BS EN ISO 75-1&2



## **RECOMMENDED PROCESSING CONDITIONS**

### **MACHINE**

It is recommended that an in-line reciprocating screw machine be used to injection mould ECP 9602.

### **CYLINDER TEMPERATURE**

230-270°C. The optimum cylinder temperature will depend upon the size and complexity of the moulding.

### **MOULD TEMPERATURE**

40-60°C. The optimum mould temperature will depend upon the size and complexity of the moulding.

### **MOULD DESIGN**

Moulds should be designed to obtain rapid filling, and multiple gates for large area mouldings are recommended with the gate positioned to avoid possible formation of weld lines.

### **MACHINE AND MOULD WEAR**

The intensive compounding action, which takes place during the manufacture of ECP 9602, ensures encapsulation of the reinforcement in polymer. This tends to minimise wear on injection screws and moulds. There is no evidence to show that ECP 9603 causes corrosion of mould steels.

### **MOISTURE**

ECP 9602 absorbs moisture, therefore, prior to moulding please ensure thorough drying (i.e., 90°C for 4 hours). Materials should be re-dried if all the material is not used within 2-3 hours of opening the bag. Excess moisture may show as splash marks on the surface of these finished mouldings. If necessary, the material should be re-dried at 80 - 90°C in shallow trays for 2-3 hours. Other forms of drying of equivalent effect are also suitable.

### **USE OF REGRIND**

Runners sprues and scrap mouldings can be reground and blended with virgin materials. Regrind additions should not exceed 10% by weight of the virgin material otherwise some reduction in properties may be experienced.

### **HEALTH & SAFETY**

**CAUTION - THIS MATERIAL IS ELECTRICALLY CONDUCTIVE**

As this material does not have the insulating properties normally associated with polymers, due safety precautions must be taken in use and it is recommended that all products made from this material are suitably labelled.

These materials are stable at ambient and normal processing temperatures and can be processed safely in moulding and extrusion equipment at up to 300°C.

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**Sales 01706 647718**



**ECP 9603**  
**CONDUCTIVE PC/PBT**  
**CARBON NANOTUBE COMPOUND**  
**INJECTION MOULDING**

ECP 9603 is a proprietary TBA PS injection moulding compound utilising multi wall carbon nanotube technology to give a permanently conductive material. Special compounding techniques at low filler loadings ensure the retention of physical properties and excellent cleanliness.

**APPLICATIONS**

Mouldings made from ECP 9603 exhibit excellent dimensional and chemical stability, and mouldings are clean and non-sloughing.

Typical applications include:

- Production aids for the electronics industry (e.g., storage boxes, bins and PCB racks.
- Static safe handling equipment tools, instruments.
- Static dissipating equipment housing and ATEX applications
- Applications requiring a degree of EMI shielding

**PROPERTIES**

Parameter	Condition	Typical Value	Unit	Test method
Surface resistance	23+/-2C	1.0E+06	ohm/sq	BS 2044:1984 /3
Volume resistance	23+/-2C	5.0E+02	ohm.cm	BS 2044:1984 /3
EMI Shielding	100MHz/1GHz	34/34	dB	Reflectometer
Specific Gravity		1.23	g/cm <sup>3</sup>	BS EN ISO 1183-1:2004
Melt flow rate	260C/5kg	3.7	g/10 min	ISO 1133:1991
Tensile strength at break	50mm/min	48.2	MPa	ISO 527-2:1997
Tensile modulus	1mm/min	1.55	GPa	ISO 527-2:1997
Elongation at break	50mm/min	13.1	%	
Flexural modulus	2mm/min	3.08	GPa	ISO 178:2003
Izod Impact	23+/-2C	35.9	KJ/m <sup>2</sup>	ISO179-1:2001
Heat deflection temp	1.8MPa	94.8	C	BS EN ISO 75-1&2



## **RECOMMENDED PROCESSING CONDITIONS**

### **MACHINE**

It is recommended that an in-line reciprocating screw machine be used to injection mould ECP 9603.

### **CYLINDER TEMPERATURE**

230-270°C. The optimum cylinder temperature will depend upon the size and complexity of the moulding.

### **MOULD TEMPERATURE**

40-60°C. The optimum mould temperature will depend upon the size and complexity of the moulding.

### **MOULD DESIGN**

Moulds should be designed to obtain rapid filling, and multiple gates for large area mouldings are recommended with the gate positioned to avoid possible formation of weld lines.

### **MACHINE AND MOULD WEAR**

The intensive compounding action, which takes place during the manufacture of ECP 9603, ensures encapsulation of the reinforcement in polymer. This tends to minimise wear on injection screws and moulds. There is no evidence to show that ECP 9603 causes corrosion of mould steels.

### **MOISTURE**

ECP 9603 absorbs moisture, therefore, prior to moulding please ensure thorough drying (i.e., 90°C for 4 hours). Materials should be re-dried if all the material is not used within 2-3 hours of opening the bag. Excess moisture may show as splash marks on the surface of these finished mouldings. If necessary, the material should be re-dried at 80 - 90°C in shallow trays for 2-3 hours. Other forms of drying of equivalent effect are also suitable.

### **USE OF REGRIND**

Runners sprues and scrap mouldings can be reground and blended with virgin materials. Regrind additions should not exceed 10% by weight of the virgin material otherwise some reduction in properties may be experienced.

### **HEALTH & SAFETY**

**CAUTION - THIS MATERIAL IS ELECTRICALLY CONDUCTIVE**

As this material does not have the insulating properties normally associated with polymers, due safety precautions must be taken in use and it is recommended that all products made from this material are suitably labelled.

These materials are stable at ambient and normal processing temperatures and can be processed safely in moulding and extrusion equipment at up to 300°C.

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## ECP 9604

### **CONDUCTIVE PC/PBT CARBON NANOTUBE HYBRID COMPOUND INJECTION MOULDING HIGH EMI SHIELDING**

ECP 9604 is a proprietary TBA PS injection moulding compound utilising multi wall carbon nanotube technology to give a permanently conductive material. Special compounding techniques at low filler loadings ensure the retention of physical properties and excellent cleanliness.

Synergistic hybrids of low levels of steel fibres ensure very high EMI shielding performance, whilst retaining good physical performance.

#### APPLICATIONS

Mouldings made from ECP 9604 exhibit excellent dimensional and chemical stability, and mouldings are clean and non-sloughing.

Typical applications include:

- Production aids for the electronics industry (e.g., storage boxes, enclosures, particularly when EMI shielding is required)
- EMI shielding equipment housing.
- Applications requiring a high level of EMI shielding

#### PROPERTIES

Parameter	Condition	Typical Value	Unit	Test method
Surface resistance	23+/-2C	1.0E+04	ohm/sq	BS 2044:1984 /3
Volume resistance	23+/-2C	2	ohm.cm	BS 2044:1984 /3
EMI Shielding	100MHz/1GHz	47/57	dB	Reflectometer
Specific Gravity		1.29	g/cm <sup>3</sup>	BS EN ISO 1183-1:2004
Melt flow rate	250C/5kg	3.3	g/10 min	ISO 1133:1991
Tensile strength at break	50mm/min	60.3	MPa	ISO 527-2:1997
Tensile modulus	1mm/min	2450	MPa	ISO 527-2:1997
Elongation at break	50mm/min	4.3	%	
Flexural modulus	2mm/min	2840	MPa	ISO 178:2003
Izod Impact	23+/-2C	10.1	KJ/m <sup>2</sup>	ISO179-1:2001
Heat deflection	1.8MPa	101	C	BS EN ISO 75-1&2

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## **RECOMMENDED PROCESSING CONDITIONS**

### **MACHINE**

It is recommended that an in-line reciprocating screw machine be used to injection mould ECP 9604.

### **CYLINDER TEMPERATURE**

230-270°C. The optimum cylinder temperature will depend upon the size and complexity of the moulding.

### **MOULD TEMPERATURE**

40-60°C. The optimum mould temperature will depend upon the size and complexity of the moulding.

### **MOULD DESIGN**

Moulds should be designed to obtain rapid filling, and multiple gates for large area mouldings are recommended with the gate positioned to avoid possible formation of weld lines.

### **MACHINE AND MOULD WEAR**

The intensive compounding action, which takes place during the manufacture of ECP 9604, ensures encapsulation of the reinforcement in polymer. This tends to minimise wear on injection screws and moulds. There is no evidence to show that ECP 9604 causes corrosion of mould steels.

### **MOISTURE**

ECP 9604 absorbs moisture, therefore, prior to moulding please ensure thorough drying (i.e., 90°C for 4 hours). Materials should be re-dried if all the material is not used within 2-3 hours of opening the bag. Excess moisture may show as splash marks on the surface of these finished mouldings. If necessary, the material should be re-dried at 80 - 90°C in shallow trays for 2-3 hours. Other forms of drying of equivalent effect are also suitable.

### **USE OF REGRIND**

Runners sprues and scrap mouldings can be reground and blended with virgin materials. Regrind additions should not exceed 10% by weight of the virgin material otherwise some reduction in properties may be experienced.

### **HEALTH & SAFETY**

**CAUTION - THIS MATERIAL IS ELECTRICALLY CONDUCTIVE**

As this material does not have the insulating properties normally associated with polymers, due safety precautions must be taken in use and it is recommended that all products made from this material are suitably labelled.

These materials are stable at ambient and normal processing temperatures and can be processed safely in moulding and extrusion equipment at up to 300°C.

*information in this publication and otherwise supplied to users is based upon our general experiences and is given in good faith, but because of the particulars which are outside our knowledge and control and affect the use of the product, no warranty is given or is implied with respect to such information. freedom from patent rights must not be assumed.*



**Sales 01706 647718**



**ECP 9703**

**CONDUCTIVE POLYCARBONATE  
CARBON NANOTUBE COMPOUND  
INJECTION MOULDING**

ECP 9703 is a proprietary TBA PS injection moulding compound utilising multi wall carbon nanotube technology to give a permanently conductive material. Special compounding techniques at low filler loadings ensure the retention of physical properties and excellent cleanliness.

**APPLICATIONS**

Mouldings made from ECP 9703 exhibit excellent dimensional and chemical stability, and mouldings are clean and non-sloughing.

Typical applications include:

- Production aids for the electronics industry (e.g., storage boxes, enclosures)
- Equipment housing.
- Applications requiring a degree of EMI shielding

**PROPERTIES**

Parameter	Condition	Typical Value	Unit	Test method
Surface resistance	23+/-2C	2.0E+05	ohm/sq	BS 2044:1984 /3
Volume resistance	23+/-2C	9.0E+01	ohm.cm	BS 2044:1984 /3
EMI Shielding	100MHz/1 GHz	31/29	dB	Reflectometer
Specific Gravity		2.6	g/cm <sup>3</sup>	BS EN ISO 1183-1:2004
Melt flow rate	300°C/5kg	1.2	g/10 min	ISO 1133:1991
Tensile strength at break	50mm/min	61.9	MPa	ISO 527-2:1997
Tensile modulus	1mm/min	2570	MPa	ISO 527-2:1997
Elongation at break	50mm/min	8.0	%	
Flexural modulus	2mm/min	2730	MPa	ISO 178:2003
Izod Impact	23+/-2C	7.1	KJ/m <sup>2</sup>	ISO179-1:2001
Heat deflection temp	1.8MPa	123	°C	BS EN ISO 75-1&2

## **RECOMMENDED PROCESSING CONDITIONS**

### **MACHINE**

It is recommended that an in-line reciprocating screw machine be used to injection mould ECP 9703.

### **CYLINDER TEMPERATURE**

270-300°C. The optimum cylinder temperature will depend upon the size and complexity of the moulding.

### **MOULD TEMPERATURE**

40-60°C. The optimum mould temperature will depend upon the size and complexity of the moulding.

### **MOULD DESIGN**

Moulds should be designed to obtain rapid filling, and multiple gates for large area mouldings are recommended with the gate positioned to avoid possible formation of weld lines.

### **MACHINE AND MOULD WEAR**

The intensive compounding action, which takes place during the manufacture of ECP 9703, ensures encapsulation of the reinforcement in polymer. This tends to minimise wear on injection screws and moulds. There is no evidence to show that ECP 9703 causes corrosion of mould steels.

### **MOISTURE**

ECP 9703 absorbs moisture, therefore, prior to moulding please ensure thorough drying (i.e.120°C for 4 hours). Materials should be re-dried if all the material is not used within 2-3 hours of opening the bag. Excess moisture may show as splash marks on the surface of these finished mouldings. If necessary, the material should be re-dried at 100°C in shallow trays for 2-3 hours. Other forms of drying of equivalent effect are also suitable.

### **USE OF REGRIND**

Runners sprues and scrap mouldings can be reground and blended with virgin materials. Regrind additions should not exceed 10% by weight of the virgin material otherwise some reduction in properties may be experienced.

### **HEALTH & SAFETY**

#### **CAUTION - THIS MATERIAL IS ELECTRICALLY CONDUCTIVE**

As this material does not have the insulating properties normally associated with polymers, due safety precautions must be taken in use and it is recommended that all products made from this material are suitably labelled.

These materials are stable at ambient and normal processing temperatures and can be processed safely in moulding and extrusion equipment at up to 350°C.

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**Sales 01706 647718**



**ECP 9905**

**CONDUCTIVE GLASS FIBRE FILLED  
POLYPHENYLENE SULPHIDE  
CARBON NANOTUBE COMPOUND  
INJECTION MOULDING**

ECP 9905 is a proprietary TBA ECP injection moulding compound utilising multi wall carbon nanotube technology to give a permanently conductive material. Special compounding techniques at low filler loadings ensure the retention of physical properties and excellent cleanliness.

ECP 9905 is a very high performance thermoplastic with a very high modulus and strength plus a very high continuous service temperature (240°C, short term exposure up to 270°C). It is inherently flame retardant (UL 94 V0), has very good chemical and oxidation resistance, very low water absorption and very low creep, even at elevated temperatures.

**APPLICATIONS**

Mouldings made from ECP 9906 exhibit excellent dimensional and chemical stability, and mouldings are clean and non-sloughing. It is suitable for the manufacture of mechanically and thermally highly stressed components.

Typical applications include:

- Hot water and fuel systems for the automotive industry
- Equipment housing.
- Aerospace components

**PROPERTIES**

Parameter	Condition	Typical Value	Unit	Test method
Volume resistance	23+/-2C	8.5 x106	ohm.cm	BS 2044:1984 /3
EMI Shielding	100MHz/1 GHz	34	dB	Reflectometer
Specific Gravity		1.64	g/cm <sup>3</sup>	BS EN ISO 1183-1:2004
Tensile strength at break	50mm/min	166	MPa	ISO 527-2:1997
Tensile sstrain at break	50mm/min	1.6	%	ISO 527-2:1997
Tensile modulus	1mm/min	11.8	GPa	ISO 527-2:1997



Flexural modulus	2mm/min	13.7	GPa	ISO 178:2003
Izod Impact	23+/-2C	5	KJ/m <sup>2</sup>	ISO179-1:2001
Heat deflection temp	1.8MPa	>260	°C	BS EN ISO 75-1&2

## **RECOMMENDED PROCESSING CONDITIONS**

### **MACHINE**

It is recommended that an in-line reciprocating screw machine be used to injection mould ECP 9703.

### **CYLINDER TEMPERATURE**

320-340°C. The optimum cylinder temperature will depend upon the size and complexity of the moulding.

### **MOULD TEMPERATURE**

140°C. Ensures proper crystallisation which optimises properties and decreases shrinkage The optimum mould temperature will depend upon the size and complexity of the moulding.

### **MOULD DESIGN**

Moulds should be designed to obtain rapid filling, and multiple gates for large area mouldings are recommended with the gate positioned to avoid possible formation of weld lines.

### **MACHINE AND MOULD WEAR**

The intensive compounding action, which takes place during the manufacture of ECP 9703, ensures encapsulation of the reinforcement in polymer. This tends to minimise wear on injection screws and moulds. There is no evidence to show that ECP 9703 causes corrosion of mould steels.

### **MOISTURE**

ECP 9906 should be dried for 3 hours at 140°C for best surface appearance.

### **USE OF REGRIND**

Runners sprues and scrap mouldings can be reground and blended with virgin materials. Regrind additions should not exceed 10% by weight of the virgin material otherwise some reduction in properties may be experienced.

### **HEALTH & SAFETY**

#### **CAUTION - THIS MATERIAL IS ELECTRICALLY CONDUCTIVE**

As this material does not have the insulating properties normally associated with polymers, due safety precautions must be taken in use and it is recommended that all products made from this material are suitably labelled.

These materials are stable at ambient and normal processing temperatures and can be processed safely in moulding and extrusion equipment at up to 370°C.

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**Sales 01706 647718**





**ECP 9906**

**CONDUCTIVE GLASS FIBRE FILLED  
POLYPHENYLENE SULPHIDE  
CARBON NANOTUBE COMPOUND  
INJECTION MOULDING**

ECP 9906 is a proprietary TBA ECP injection moulding compound utilising multi wall carbon nanotube technology to give a permanently conductive material. Special compounding techniques at low filler loadings ensure the retention of physical properties and excellent cleanliness.

ECP 9906 is a very high performance thermoplastic with a very high modulus and strength plus a very high continuous service temperature (240°C, short term exposure up to 270°C). It is inherently flame retardant (UL 94 V0), has very good chemical and oxidation resistance, very low water absorption and very low creep, even at elevated temperatures.

**APPLICATIONS**

Mouldings made from ECP 9906 exhibit excellent dimensional and chemical stability, and mouldings are clean and non-sloughing. It is suitable for the manufacture of mechanically and thermally highly stressed components.

Typical applications include:

- Hot water and fuel systems for the automotive industry
- Equipment housing.
- Aerospace components

**PROPERTIES**

Parameter	Condition	Typical Value	Unit	Test method
Volume resistance	23+/-2C	4 x10 <sup>3</sup>	ohm.cm	BS 2044:1984 /3
EMI Shielding	100MHz/1 GHz	34	dB	Reflectometer
Specific Gravity		1.64	g/cm <sup>3</sup>	BS EN ISO 1183-1:2004
Tensile strength at break	50mm/min	151	MPa	ISO 527-2:1997
Tensile strain at break	50mm/min	1.4	%	ISO 527-2:1997
Tensile modulus	1mm/min	10..8	GPa	ISO 527-2:1997

Flexural modulus	2mm/min	12.9	GPa	ISO 178:2003
Izod Impact	23+/-2C	4.4	KJ/m <sup>2</sup>	ISO179-1:2001
Heat deflection temp	1.8MPa	255	°C	BS EN ISO 75-1&2

## **RECOMMENDED PROCESSING CONDITIONS**

### **MACHINE**

It is recommended that an in-line reciprocating screw machine be used to injection mould ECP 9906.

### **CYLINDER TEMPERATURE**

320 -340°C. The optimum cylinder temperature will depend upon the size and complexity of the moulding.

### **MOULD TEMPERATURE**

>140°C. Ensures proper crystallisation of the material. This will optimise properties and decrease shrinkage. The optimum mould temperature will depend upon the size and complexity of the moulding.

### **MOULD DESIGN**

Moulds should be designed to obtain rapid filling, and multiple gates for large area mouldings are recommended with the gate positioned to avoid possible formation of weld lines.

### **MACHINE AND MOULD WEAR**

The intensive compounding action, which takes place during the manufacture of ECP 9703, ensures encapsulation of the reinforcement in polymer. This tends to minimise wear on injection screws and moulds. There is no evidence to show that ECP 9703 causes corrosion of mould steels.

### **MOISTURE**

ECP 9906 for optimal surface appearance we recommend at least 3 hours drying at 140°C.

### **USE OF REGRIND**

Runners sprues and scrap mouldings can be reground and blended with virgin materials. Regrind additions should not exceed 10% by weight of the virgin material otherwise some reduction in properties may be experienced.

### **HEALTH & SAFETY**

**CAUTION - THIS MATERIAL IS ELECTRICALLY CONDUCTIVE**

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